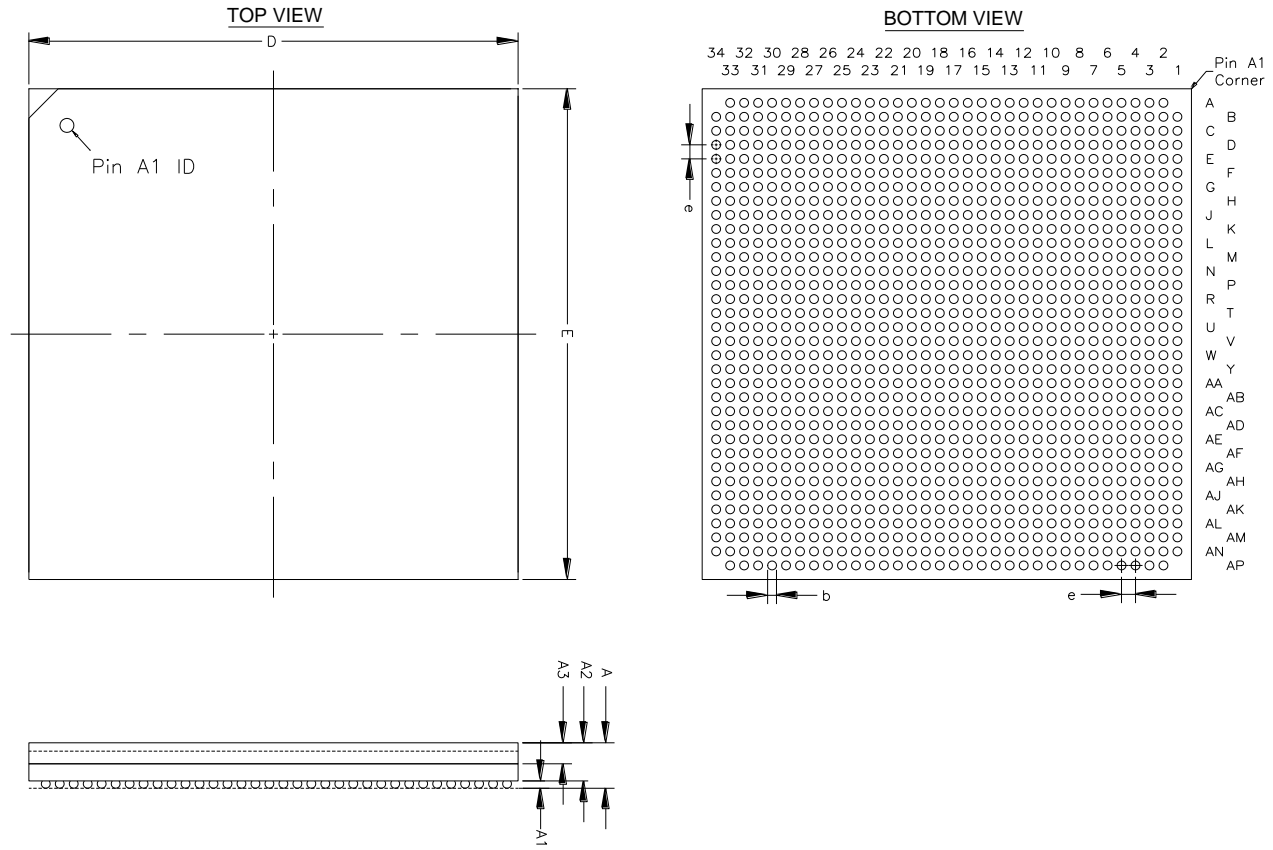


## 1152-Pin FineLine Ball-Grid Array (FBGA) - Flip Chip - Channel Lid - A:3.60

- All dimensions and tolerances conform to ASME Y14.5M – 1994.
- Controlling dimension is in millimeters.
- Pin A1 may be indicated by an ID dot, or a special feature, in its proximity on package surface.

Package Information	
Description	Specification
Ordering Code Reference	F
Package Acronym	FBGA
Substrate Material	BT
Solder ball composition	Regular: 63Sn:37Pb (Typ.) Pb-free: Sn:3Ag:0.5Cu (Typ.)
JEDEC Outline Reference	MS-034 Variation: AAR-1
Lead Coplanarity	0.008 inch (0.20 mm)
Weight	13.8 g (Typ.)
Moisture Sensitivity Level	Printed on moisture barrier bag

Package Outline Dimension Table			
Symbol	Millimeters		
	Min.	Nom.	Max.
A	3.20	3.40	3.60
A1	0.40	0.50	0.60
A2	2.60	2.90	3.20
A3	1.45	1.55	1.65
D	35.00 BSC		
E	35.00 BSC		
b	0.50	0.60	0.70
e	1.00 BSC		

**Package Outline**

## Document Revision History

Table 1 shows the revision history for this document.

Table 1. Document Revision History

Date	Version	Changes
June 2011	1.0	Initial release
November 2012	2.0	Revised Package Outline at Page 2 to include the chamfer at TOP VIEW and update the SIDE VIEW.



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